TECHNICAL DATA Data Sheet 4098, Rev. D

Three-Phase IGBT BRIDGE, With Gate Driver and Optical Isolation

DESCRIPTION: A 600 VOLT, 80 AMP, THREE PHASE IGBT BRIDGE

ELECTRICAL CHARACTERISTICS PER IGBT DEVICE

(Tj=25°C UNLESS OTHERWISE SPECIFIED)

ELECTRICAL CHARACTERISTICS FER IGBT DEVICE		(1)=23 C UNLEGG OTTIERWISE GFECTITED)					
PARAMETER		SYMBOL	MIN	TYP	MAX	UNIT	
IGBT SPECIFICATIONS							
Collector to Emitter Breakdown Voltage $I_C = 250 \mu A, V_{GE} = 0V$		BV _{CES}	600	-	-	V	
Continuous Collector Current	$T_C = 25$ °C $T_C = 90$ °C	I _C	-	-	80 70	А	
Pulsed Collector Current, 1mS		I _{CM}	-	-	170	А	
Gate to Emitter Voltage		V_{GE}	-	-	+/-20	V	
Gate-Emitter Leakage Current , V _{GE} = +/-20V		I _{GES}	-	-	+/- 100	nA	
Zero Gate Voltage Collector Current $V_{CE} = 600 \text{ V}, V_{GE} = 00 \text{ V}, V_{GE} = 125 ^{\circ}\text{C}$ $V_{CE} = 480 \text{ V}, V_{GE} = 00 \text{ T}_{i} = 125 ^{\circ}\text{C}$		I _{CES}	-	-	1 10	mA mA	
Collector to Emitter Saturation Voltage, $I_C = 60A$, $V_{GE} = 15V$,	$T_C = 25$ °C	V _{CE(SAT)}	-	1.7	2.0	V	
Maximum Thermal Resistance		$R_{ heta JC}$	-	-	0.45	°C/W	
Brake IGBT SPECIFICATIONS					_		
Continuous Collector Current	$T_C = 25$ °C $T_C = 90$ °C	I _C	-	-	40 25	А	
Pulsed Collector Current, 0.5mS		I _{CM}	-	-	120	А	
Brake Resistor SPECIFICATIONS							
Maximum Continuous power dissipation		Pd			2	watt	
Impulse Energy					80	Joules	
Maximum operating Junction Temperature		T _{jmax}	-40	-	150	°C	
Maximum Storage Junction Temperature		T _{jmax}	-55	-	150	°C	

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Over-Temperature Shutdown					
Over-Temperature Shutdown	Tsd	100	110	120	°C
Over-Temperature Output	Tso		10		10mV/°C
Over-Temperature Shutdown Hysteresis			20		°C

Diode Peak Inverse Voltage	PIV	600	-	-	V
Continuous Forward Current, T _C = 90 °C	I _F	-	-	60	Α
Forward Surge Current, t _p = 10 msec	I _{FSM}	-	-	300	А
Diode Forward Voltage, $I_F = 60A$	V _F	-	1.4	1.7	V
Diode Reverse Recovery Time (I_F =60A, V_{RR} =300V , di/dt=200 A/ μ s)	t _{rr}	-	90	160	nsec
Maximum Thermal Resistance	$R_{ ext{ text{ text{ text{ text{ ext{ ext{$	-	-	0.8	°C/W
Gate Driver					
Supply Voltage	VCC	10	15	20	V
Input On Current	HIN, LIN	2		5.0	mA
Opto-Isolator Logic High Input Threshold	I _{th}	-	1.6	-	mA
Input Reverse Breakdown Voltage	BV _{in}	5.0	-	-	V
Input Forward Voltage @ I _{in} = 5mA	V _F	-	1.5	1.7	V
Under Voltage Lockout	VCCUV	11.5	-	12.5	V
ITRIP Reference Voltage (1)	Itrip-ref	2.9	3.0	3.1	V
Input-to-Output Turn On Delay	t _{ond}	-		800	nsec
Output Turn On Rise Time	t _r	-		100	
Input-to-Output Turn Off Delay		-			
Output Turn Off Fall Time	t _{offd}	-		1000	
@ VCC=300V, IC=50A, $T_C = 25$	t _f			100	
Input-Output Isolation Voltage	-	1000	-	-	V

⁽¹⁾ ITRIP Cycle-by cycle current limit is internally set to 70A peak. The set point can be lowered by connecting a resistor between Itrip-ref and Gnd. The set point can be increased by connecting a resistor between Itrip-ref and +5V ref

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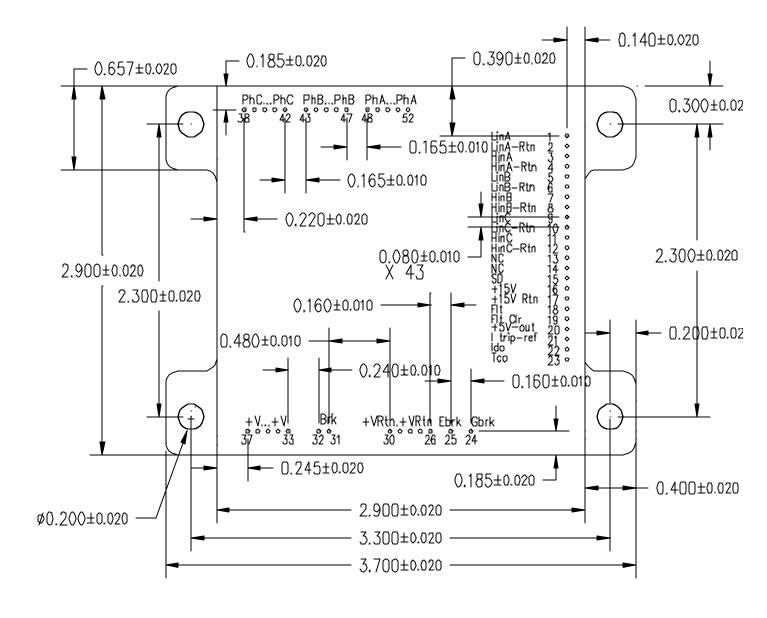
Pin Description

Pin Number	Function	Pin Number	Function	
1	Isolated Input for Low-side IGBT of Phase A	17	+15V Rtn (Signal Ground)	
2	Return for Input at 1	18	Fault Output ⁽³⁾	
3	Isolated Input for High-side IGBT of Phase A	19	Fault Clear Input ⁽³⁾	
4	Return for Input at 3	20	+5V Output	
5	Isolated Input for Low -side IGBT of Phase B	21	Over-Current Trip Set point (3)	
6	Return for Input at 5	22	DC Bus Current Output with Total Gain of 0.0365 V/A	
7	Isolated Input for High-side IGBT of Phase B	23	Case Temperature Output with a gain of 0.010 V/°C	
8	Return for Input at 7	24	Brake IGBT Gate Input	
9	Isolated Input for Low-side IGBT of Phase C	25	Brake IGBT Emitter Input. This input is internally connected to Signal Ground	
10	Return for Input at 9	26 to 30	DC Bus return	
11	Isolated Input for High-side IGBT of Phase C	31 , 32	Brake Resistor Terminal. Brake Resisto Shall be Connected Between These Terminals and +VDC	
12	Return for Input at 11	33 to 37	DC Bus "+VDC" input	
13	NC	38 to 42	Phase C output	
14	NC	43 to 47	Phase B output	
15	SD ⁽³⁾	48 to 52	Phase A output	
16	+15V Input	Case	Isolated	

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Package Drawing Top View:



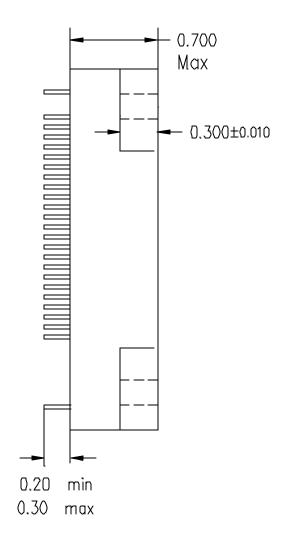
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Package Drawing Side View:



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Application Notes:

a- Shutdown Feature:

- **1-** SD is a dual function input/output, active low input. It is internally pulled high. As a low input shuts down all IGBTs regardless of the Hin and Lin signals.
- **2-** SD is also internally activated by the over-temperature shutdown, over-current limit, undervoltage shutdown, and desaturation protection.
- **3-** Over-temperature shutdown, and over-current limit are not latching features.
- **4-** Under-voltage shutdown is automatically reset after 300 msec once the VCC rises above the threshold limit.
- **5-** Desaturation shutdown is a latching feature and internally reset after 300 msec.
- **6-** When any of the internal protection features is activated, SD is pulled down.
- **7-** SD can be used to shutdown all IGBTs except the brake IGBT by an external command. An open collector switch shall be used to pull down SD externally.
- **8-** Also, SD can be used as a fault condition output. Low output at SD indicates a fault situation.

b- Fault Output Feature:

- 1- Pin 18 Flt is a dual function pin. It is internally pulled high. If pulled down, it will freeze the status of all the six IGBTs regardless of the Hin and Lin signals
- **2-** Pin 18 as an output reports desaturation protection activation. When desaturation protection is activated a low output for about 9 µsec is reported.
- **3-** If any other protection feature is activated, it will not be reported by Pin 18.

c- Fault Clear Output:

- **1-** Pin 19 is a fault clear input. It can be used to reset a latching fault condition, due to desaturation protection.
- **2-** Pin 19 is internally pulled down. A latching fault due to desaturation can be cleared by pulling high this input.
- **3-** An internal fault clear is activated after 300 msec delay. If desired to clear the fault earlier, this input can be used.



TECHNICAL DATA

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